



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Salman Akram

Serial No.: 10/602,253

Filed: June 23, 2003

For: SEMICONDUCTOR SUBSTRATE-BASED BGA INTERCONNECTION FOR TESTING SEMICONDUCTOR DEVICES
(as amended)

Confirmation No.: 1942

Examiner: L. Andujar

Group Art Unit: 2826

Attorney Docket No.: 2269-3091.5US
(96-0890.04/US)

Notice of Allowance Mailed:

June 13, 2005

NOTICE OF EXPRESS MAILING

Express Mail Mailing Label Number: EL994845927US

Date of Deposit with USPS: September 13, 2005

Person making Deposit: Steve Wong

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Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the Specification appear on page 3 of this paper.

Amendments to the Abstract appear on page 4 of this paper.

AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)

Amendments to the Claims are reflected in the listing of claims which begins on page 5 of this paper.

Remarks begin on page 8 of this paper.